

TOSHIBA INSULATED GATE BIPOLAR TRANSISTOR SILICON N CHANNEL IGBT

GT60M302

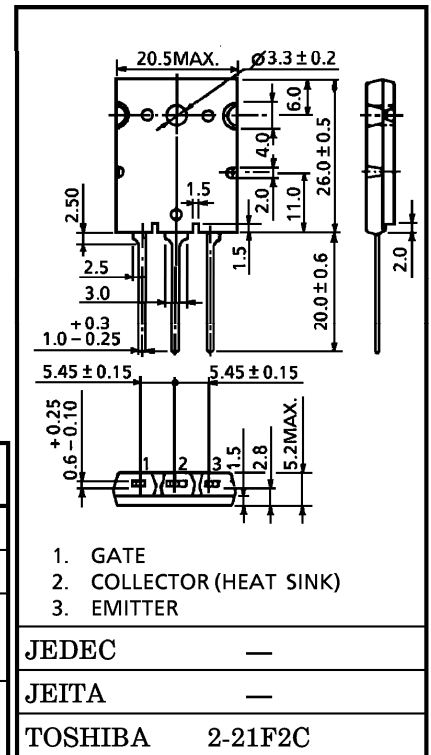
HIGH POWER SWITCHING APPLICATIONS

Unit in mm

- The 3rd Generation
- FRD Included Between Emitter and Collector
- Enhancement-Mode
- High Speed IGBT : $t_f = 0.22\mu s$ (TYP.)
FRD : $t_{rr} = 0.7\mu s$ (TYP.)
- Low Saturation Voltage : $V_{CE(sat)} = 3.3V$ (MAX.)

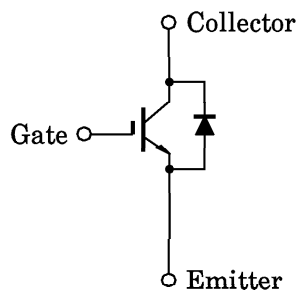
MAXIMUM RATINGS ($T_a = 25^\circ C$)

CARACTERISTICS	SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage	V_{CES}	900	V
Gate-Emitter Voltage	V_{GES}	± 25	V
Collector Current	DC	I_C	60
	1ms	I_{CP}	120
Emitter-Collector Forward Current	DC	I_{ECF}	15
	1ms	I_{ECFP}	120
Collector Power Dissipation ($T_c = 25^\circ C$)	P_C	200	W
Junction Temperature	T_j	150	$^\circ C$
Storage Temperature Range	T_{stg}	$-55 \sim 150$	$^\circ C$
Screw Torque	—	0.8	N·m



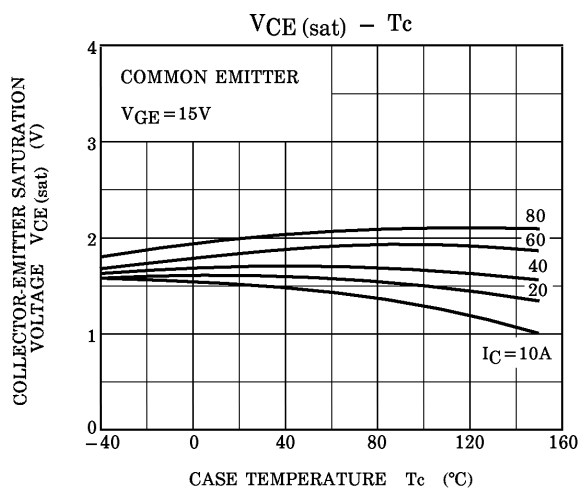
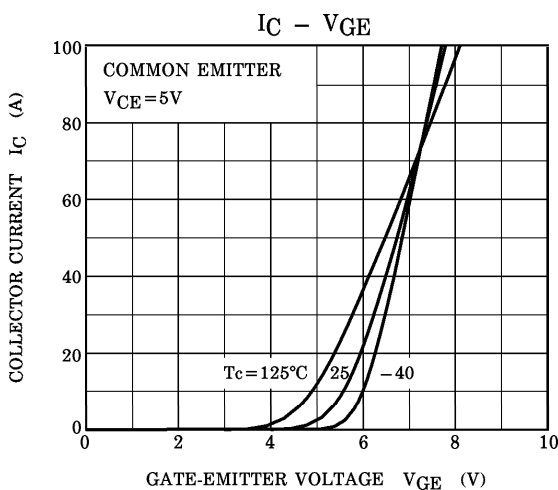
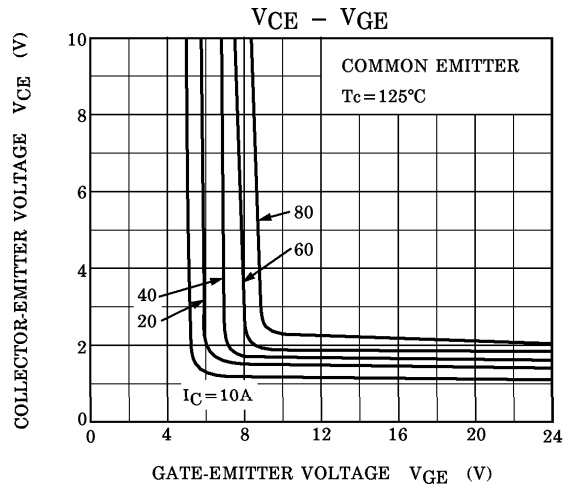
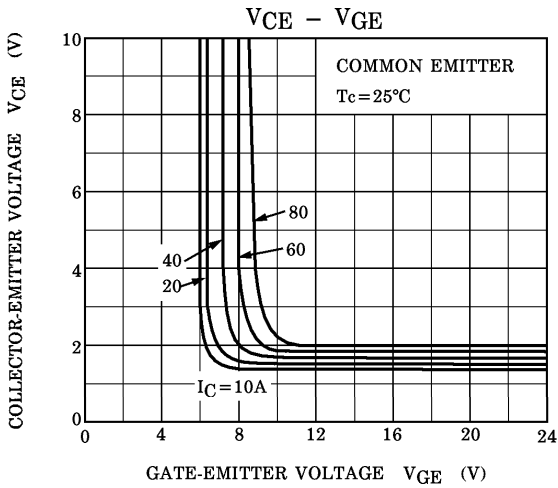
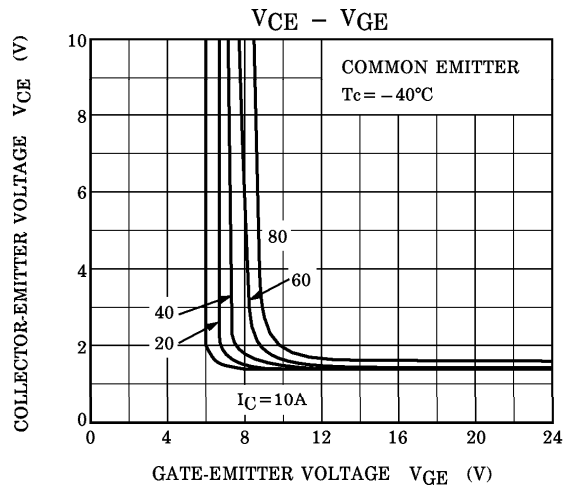
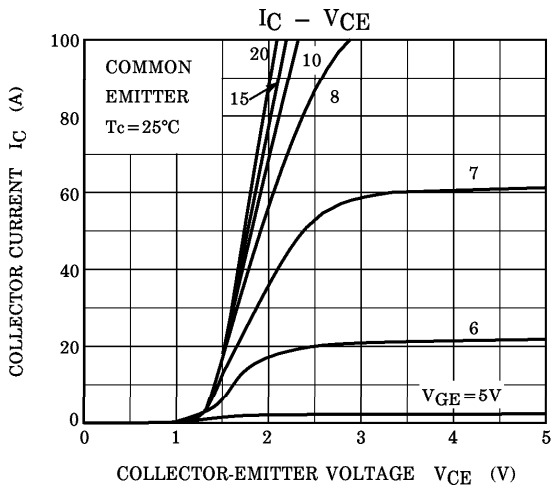
Weight : 9.75g

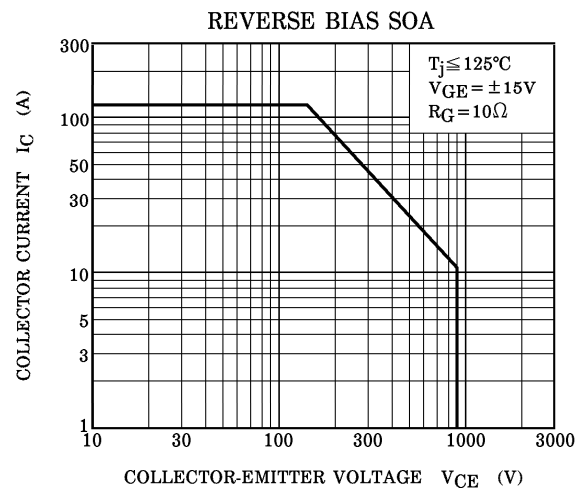
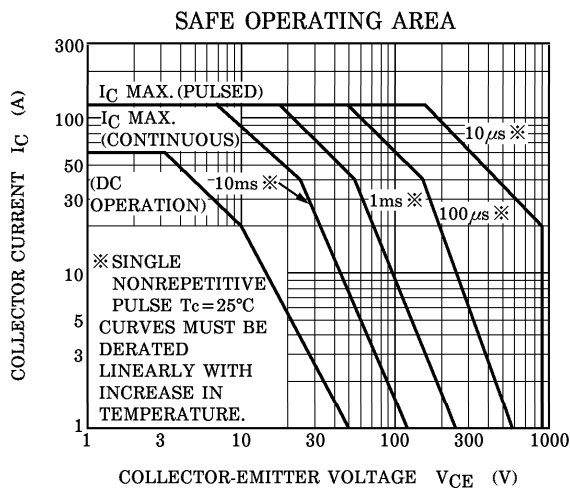
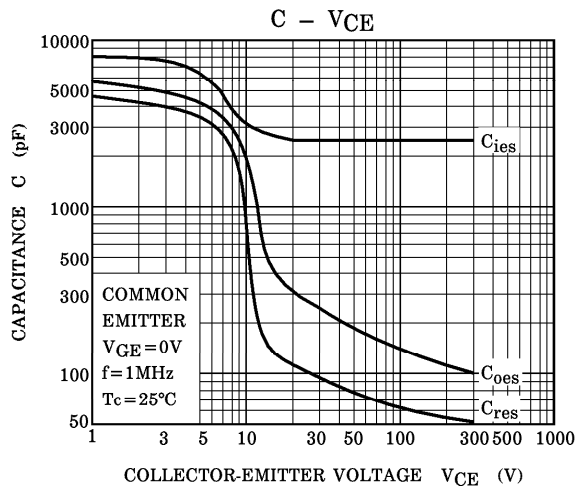
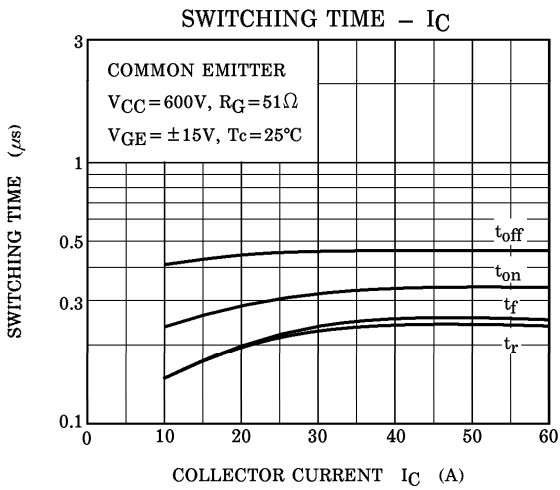
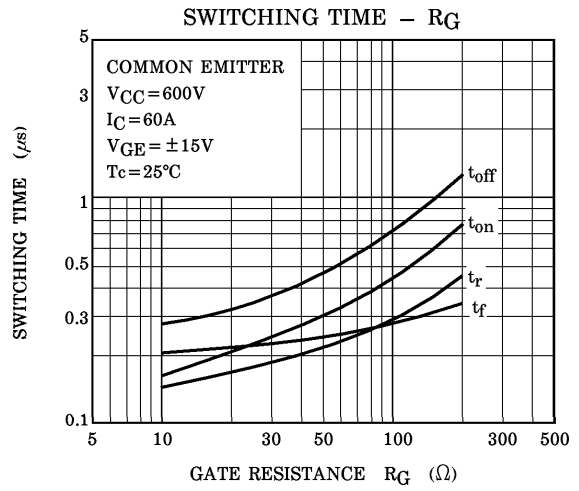
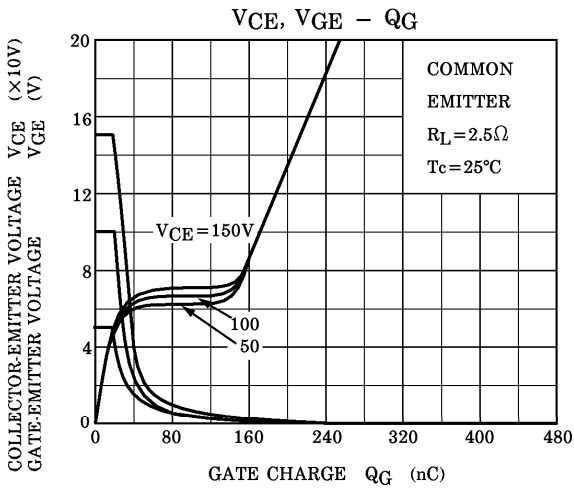
EQUIVALENT CIRCUIT

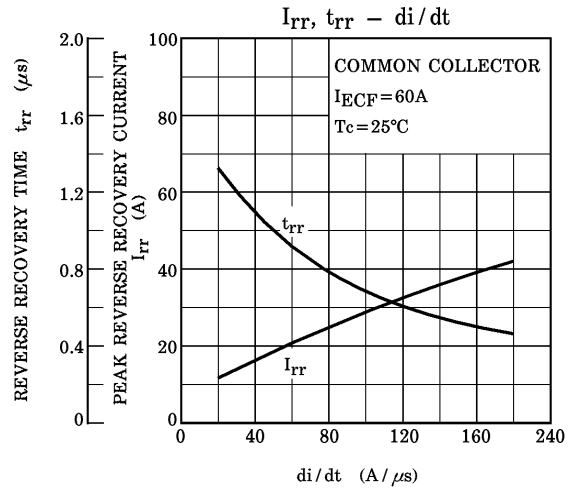
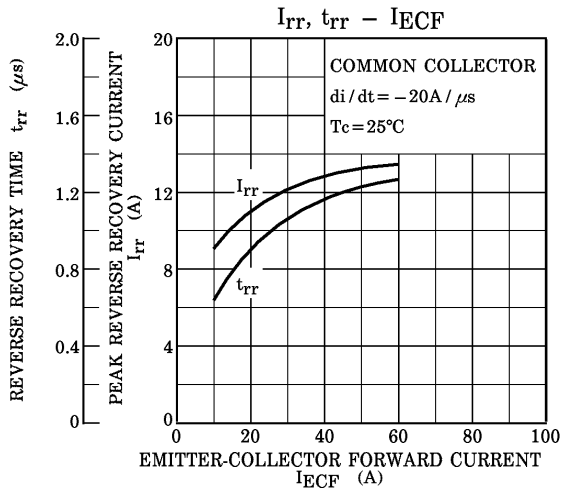
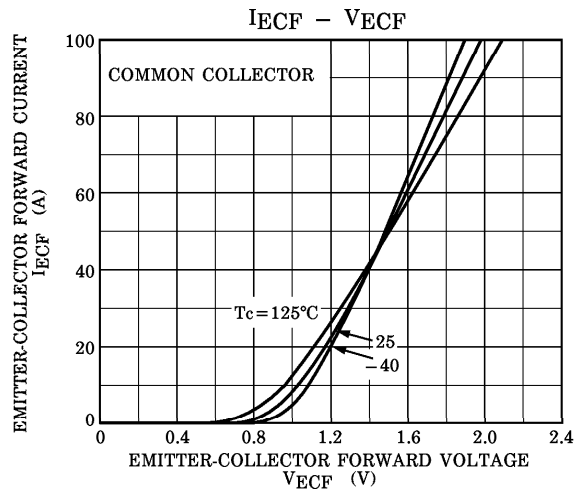
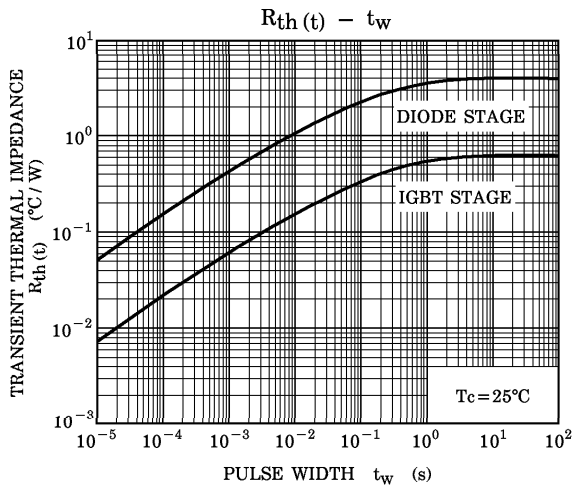


ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I _{GES}	V _{GE} = ±25V, V _{CE} = 0	—	—	±500	nA
Collector Cut-off Current		I _{CES}	V _{CE} = 900V, V _{GE} = 0	—	—	1.0	mA
Gate-Emitter Cut-off Voltage		V _{GE (OFF)}	I _C = 60mA, V _{CE} = 5V	3.0	—	6.0	V
Collector-Emitter Saturation Voltage		V _{CE (sat) (1)}	I _C = 10A, V _{GE} = 15V	—	1.6	2.4	V
Collector-Emitter Saturation Voltage		V _{CE (sat) (2)}	I _C = 60A, V _{GE} = 15V	—	2.2	3.3	V
Input Capacitance		C _{ies}	V _{CE} = 30V, V _{GE} = 0 f = 1MHz	—	4400	—	pF
Switching Time	Rise Time	t _r		—	0.25	0.60	μs
	Turn-on Time	t _{on}		—	0.35	0.80	
	Fall Time	t _f		—	0.22	0.37	
	Turn-off Time	t _{off}		—	0.50	1.00	
Emitter-Collector Forward Voltage		V _{ECF}	I _{ECF} = 15A, V _{GE} = 0	—	1.5	2.0	V
Reverse Recovery Time		t _{rr}	I _{ECF} = 15A, V _{GE} = 0 di / dt = -20A / μs	—	0.7	2.5	μs
Thermal Resistance		R _{th (j-c)}	IGBT	—	—	0.625	°C / W
Thermal Resistance		R _{th (j-c)}	Diode	—	—	4.0	°C / W







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